

● General Description

The AGM60P30C combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$

This device is ideal for load switch and battery protection applications.

● Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

● Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM60P30C	AGM60P30C	TO-220	----	----	1000

Product Summary

BVDSS	RDSON	ID
-60V	52mΩ	-30A

TO-220 Pin Configuration

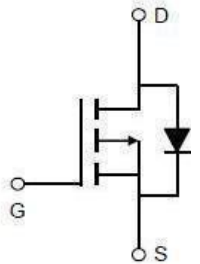


Table 1. Absolute Maximum Ratings (TC=25°C)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	-60	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25°C) (Note 1)	-30	A
	Drain Current-Continuous(Tc=100°C)	-12	A
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 2)	-120	A
PD	Maximum Power Dissipation(Tc=25°C)	34	w
	Maximum Power Dissipation(Tc=100°C)	13	w
EAS	Avalanche energy (Note 3)	35.4	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹	---	62.5	°C/W
RθJC	Thermal Resistance Junction-Case ¹	---	3.6	°C/W

Table 3. Electrical Characteristics (T_j=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=-250μA	-60	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=-60V, VGS=0V	--	--	-1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V, VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS, ID=-250μA	-1.2	-1.6	-2.1	V
gFS	Forward Transconductance	VDS=5V, ID=-6A	--	13	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-15A	--	52	62	mΩ
		VGS=-4.5V, ID=-6A	--	65	75	mΩ
Dynamic Characteristics						
Ciss	Input Capacitance	VDS=-30V, VGS=0V, F=1MHZ	--	1450	--	pF
Coss	Output Capacitance		--	64	--	pF
Crss	Reverse Transfer Capacitance		--	47	--	pF
Rg	Gate resistance	f=1.0MHz	--	--	--	Ω
Switching Times						
td(on)	Turn-on Delay Time	VGS=-10V, VDS=-30V, ID=-12A, RGEN=2.5Ω	--	28	--	nS
tr	Turn-on Rise Time		--	19	--	nS
td(off)	Turn-Off Delay Time		--	60	--	nS
tf	Turn-Off Fall Time		--	7.2	--	nS
Qg	Total Gate Charge	VGS=-10V, VDS=-15V, ID=-12A	--	9.8	--	nC
Qgs	Gate-Source Charge		--	3.1	--	nC
Qgd	Gate-Drain Charge		--	2.9	--	nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)		--	--	-30	A
VSD	Forward on Voltage	VGS=0V, IS=-12A	--	--	-1.2	V
trr	Reverse Recovery Time	Isd=-12A , di/dt=100A/μs , TJ=25°C	--	--	--	ns
Qrr	Reverse Recovery Charge		--	--	--	nc

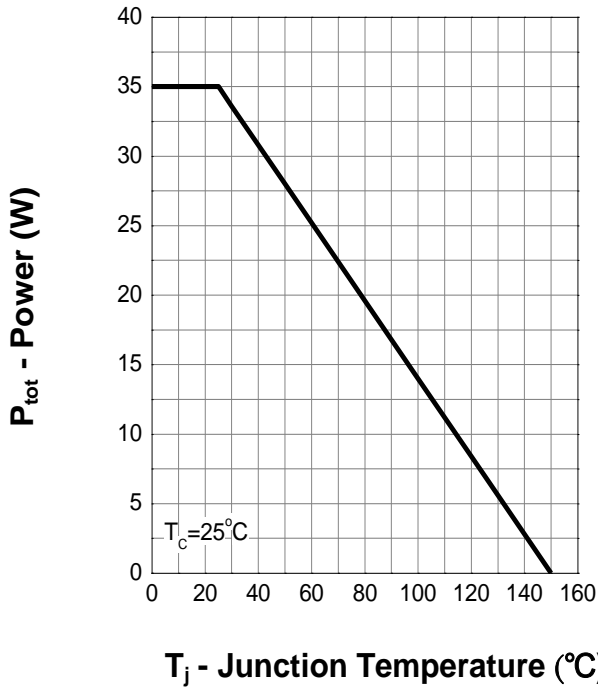
Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

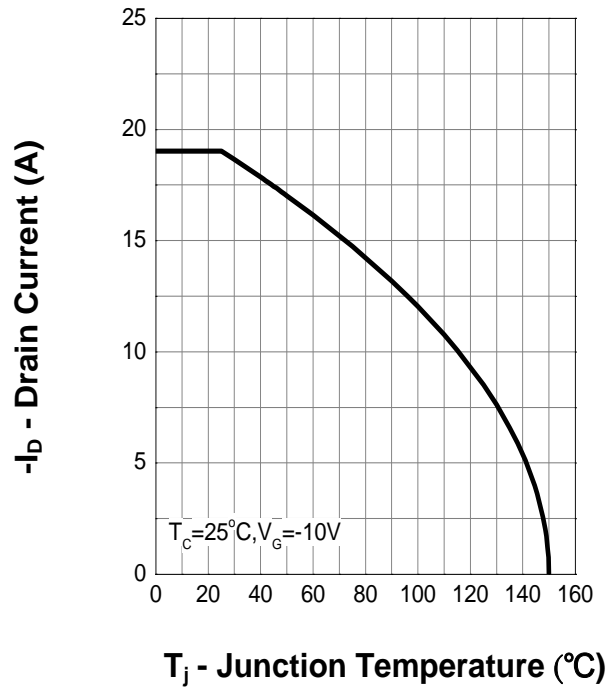
Notes 3.EAS condition: TJ=25°C

Typical Characteristics

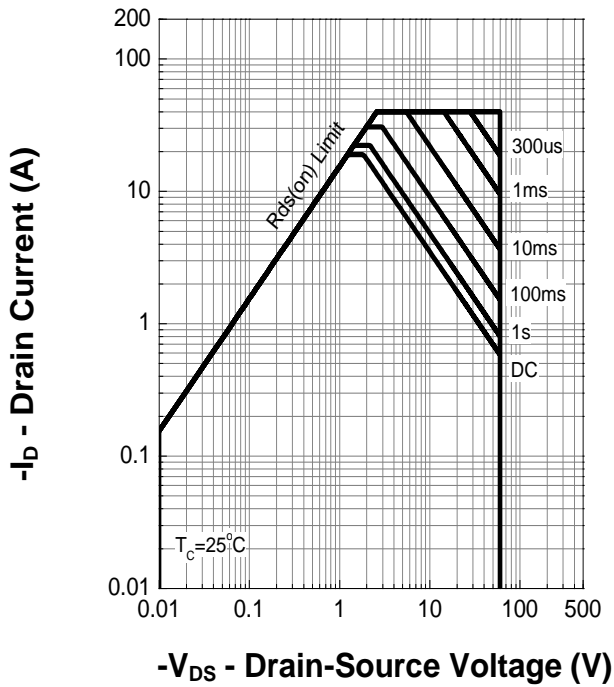
Power Dissipation



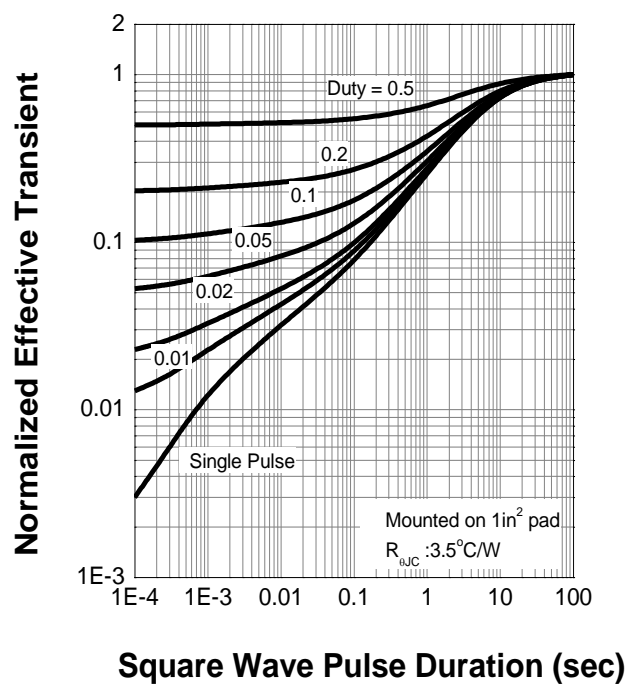
Drain Current



Safe Operation Area

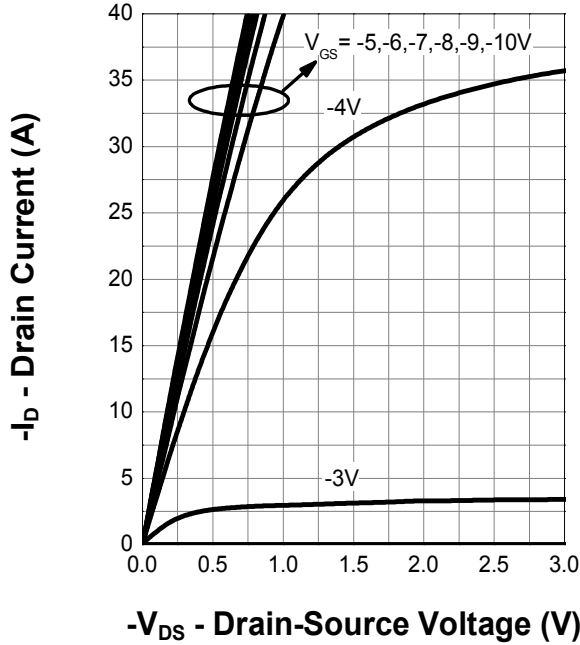


Thermal Transient Impedance

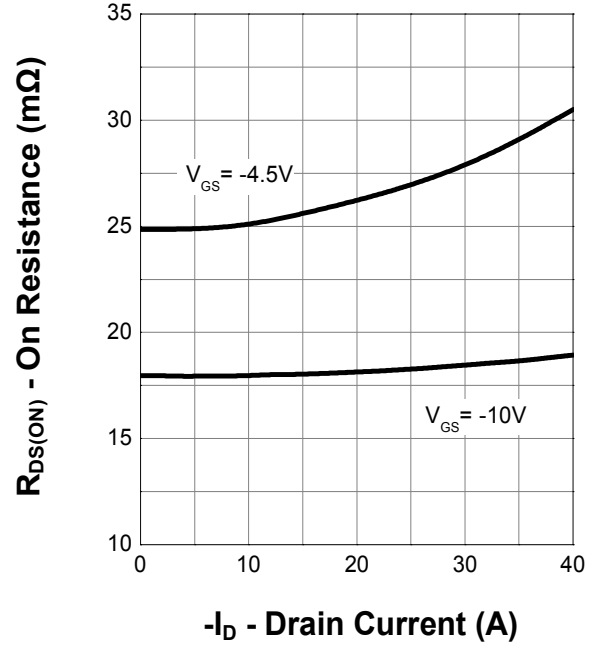


Typical Characteristics (Cont.)

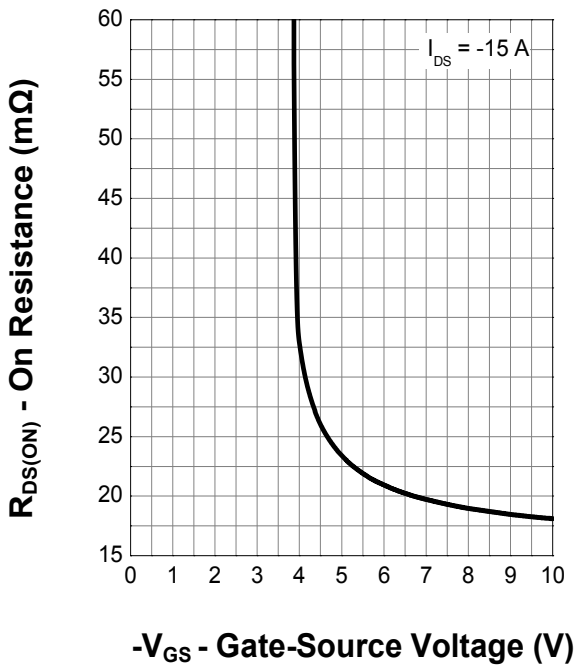
Output Characteristics



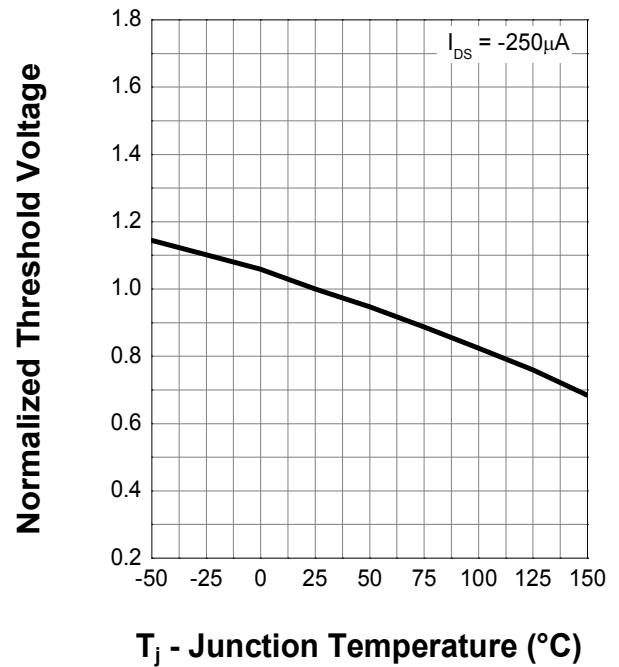
Drain-Source On Resistance



Transfer Characteristics

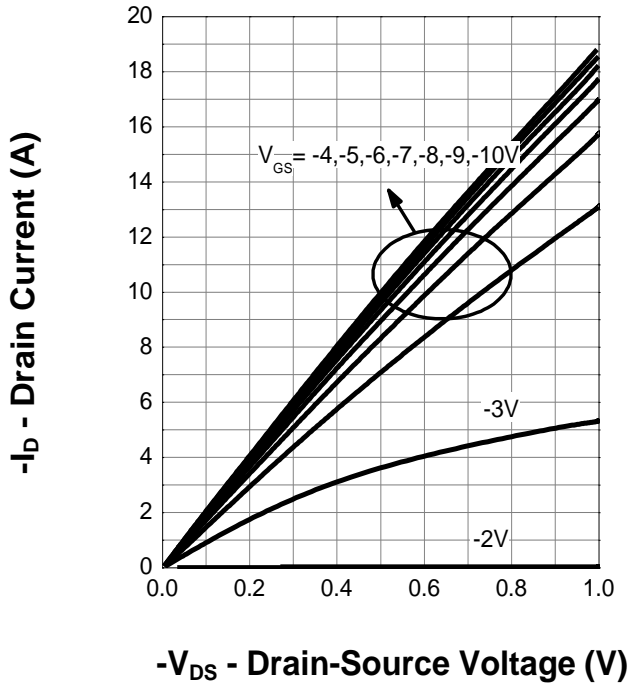


Normalized Threshold Voltage

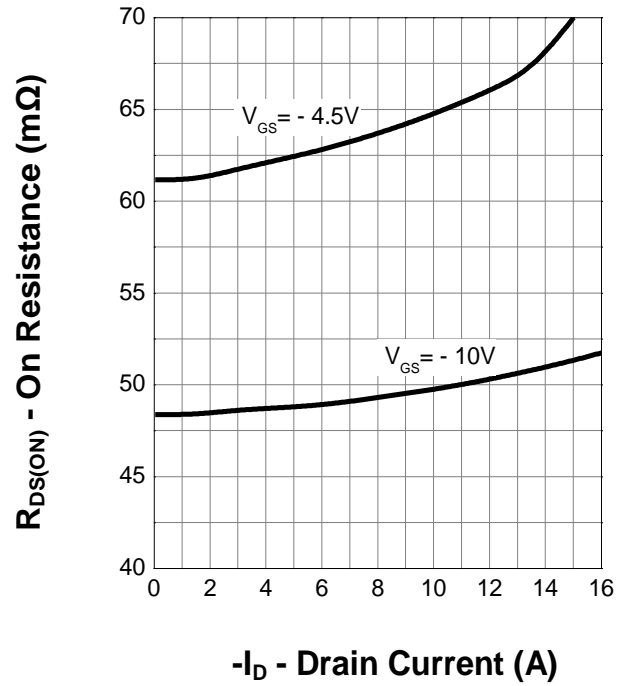


Typical Characteristics (cont.)

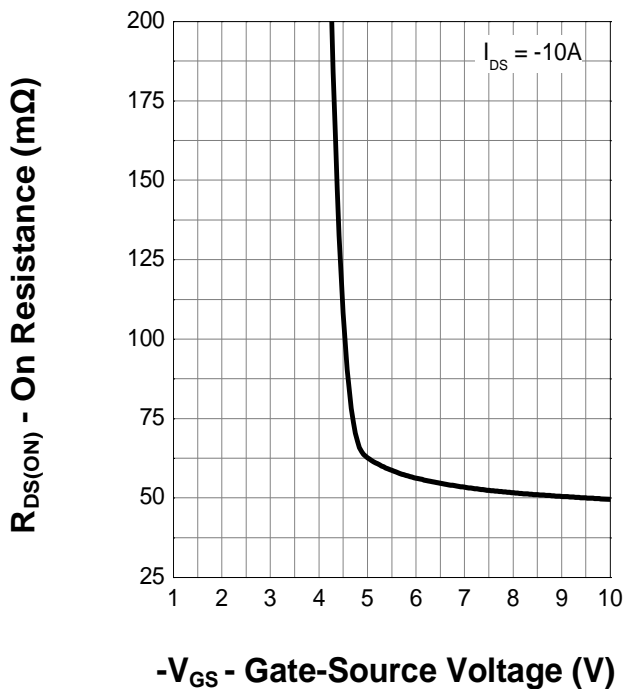
Output Characteristics



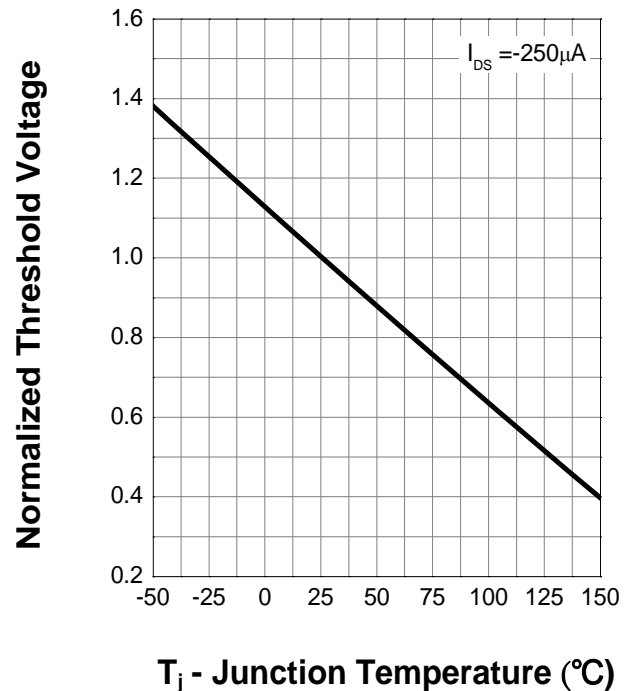
Drain-Source On Resistance



Transfer Characteristics

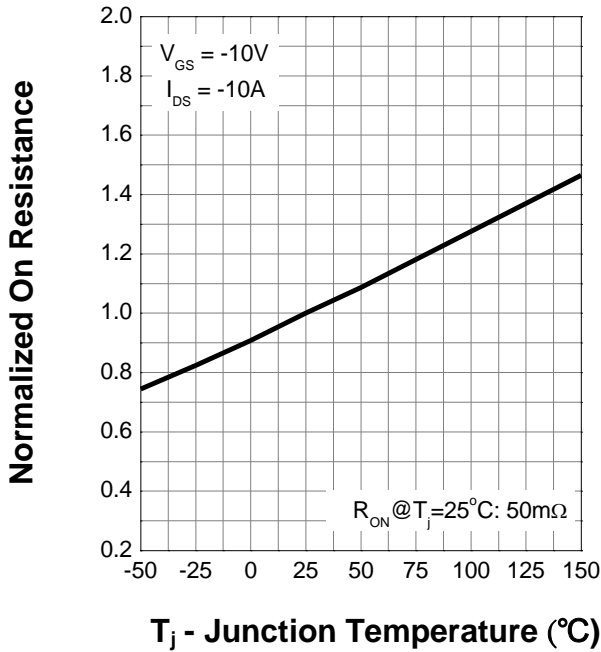


Gate Threshold Voltage

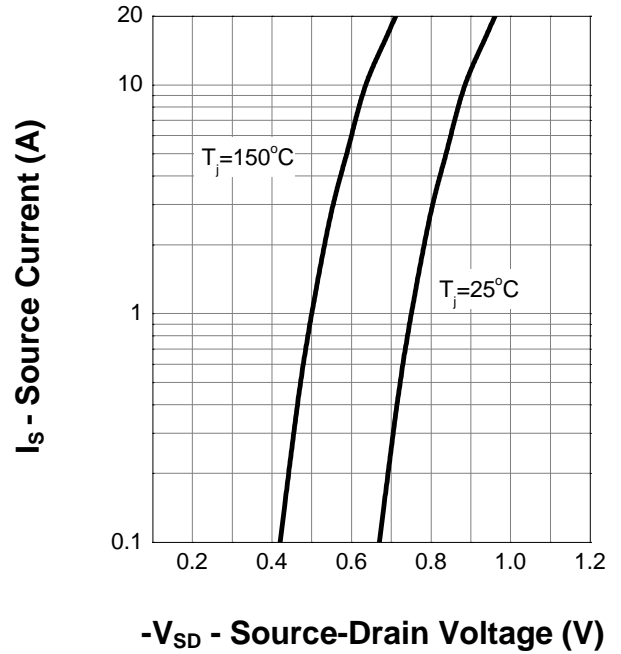


Typical Characteristics (cont.)

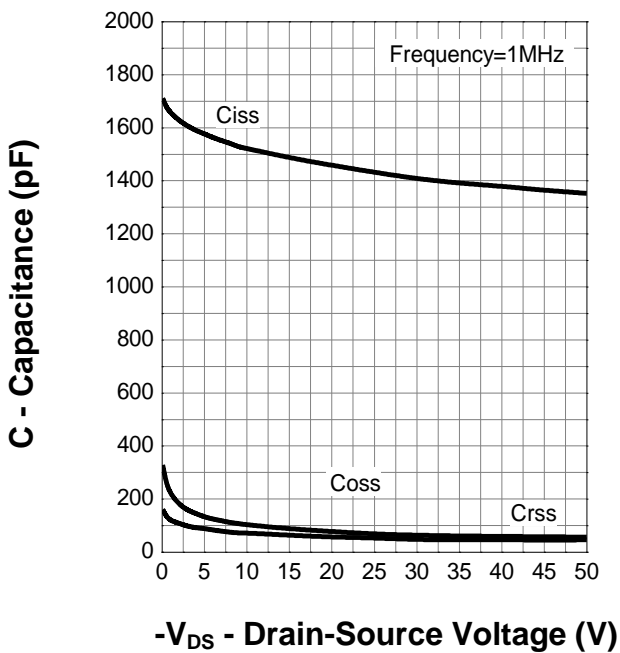
Drain-Source On Resistance



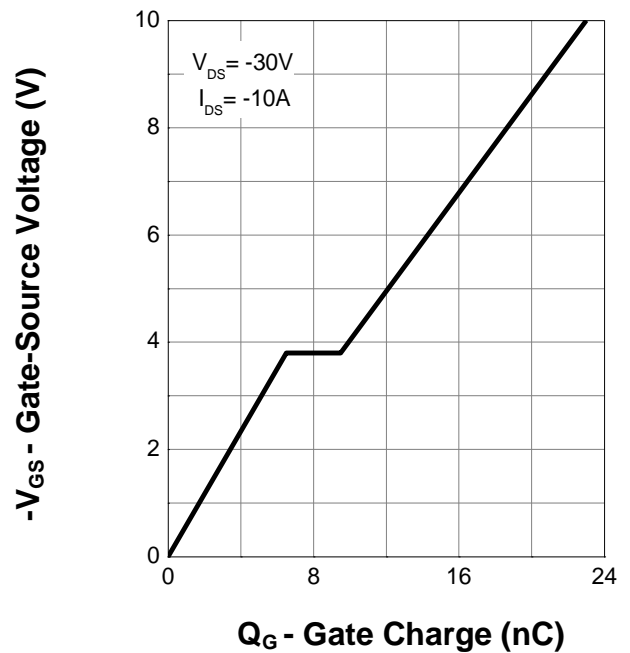
Source-Drain Diode Forward



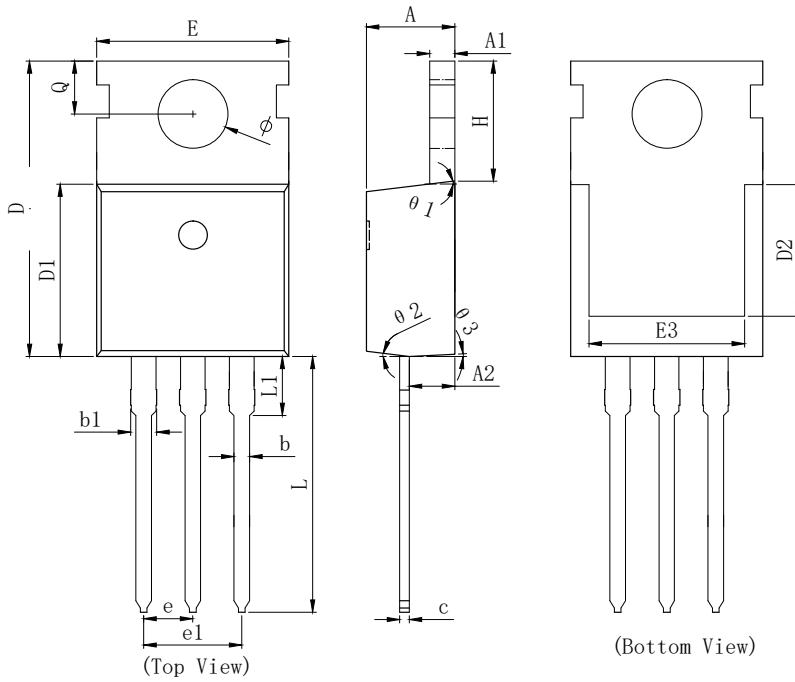
Capacitance



Gate Charge



TO-220 PACKAGE INFORMATION



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	4.370	4.570	4.700
A1	1.250	1.300	1.400
A2	2.150	2.350	2.550
b	0.700	0.800	0.950
b1	1.170	1.270	1.470
c	0.450	0.500	0.600
D	15.100	15.600	16.100
D1	8.800	9.100	9.400
D2	5.500	6.300 REF	
E	9.700	10.000	10.300
E3	7.000	7.600 REF	
e	2.540 BSC		
e1	5.080 BSC		
L	13.200	13.500	13.800
L1		3.100	3.400
H	6.250	6.500	6.750
ϕ	3.400	3.600	3.800
Q	2.600	2.800	3.000
$\theta 1$	7° TYP		
$\theta 2$	7° TYP		
$\theta 3$	3° TYP		


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